

**EDI441024C**

1Megx4 Fast Page DRAM

1 Megabit x 4 Dynamic RAM**5V, Fast Page****Features****1 Meg x 4 bit CMOS Dynamic****Random Access Memory**

- Access Times: 70, 80 and 100ns
- 16ms Refresh Rate
- Low Operating Power Dissipation
- Low Standby Power
- Common I/O
- All Inputs/Outputs TTL Compatible

Package Style

- 20 pin Ceramic ZIP, No.18
- 24/28 Thinpack™ Flatpack, No.317
- 24/28 pin Flatpack, No. 347

Single +5V ($\pm 10\%$) Supply Operation

The EDI441024C is a high performance, low power CMOS Dynamic RAM organized as 1 Megabit x 4.

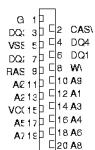
During READ and WRITE cycles each bit is addressed through 20 address bits which are entered 10 at a time (A0-A9). RAS\ is used to latch the first 10 bits and CAS\, the second 10 bits. A READ or WRITE cycle is selected with the W\ input. A logic HIGH on W\ dictates READ mode, while a logic LOW on W\ dictates WRITE mode.

During a WRITE cycle Data-in is latched by the falling edge of W\ or CAS\, whichever occurs last. If W\ goes low prior to CAS\ going LOW, the output pins remain open (HIGH-Z) until the next CAS\ cycle, regardlesses of the status of G\|. If W\ goes LOW after data reaches the output pins, Data-out pins are activated and retain the selected cell data as long as CAS\ and G\| remain LOW, until W\ goes Low. This late W\ pulse results in a DELAYED WRITE or READ-WRITE cycle. The four data inputs and four data outputs are routed through four pins using common I/O and pin direction is controlled by W\ and G\|. FAST PAGE MODE operations allow faster data operations, READ, WRITE or READ-MODIFY-WRITE, within a row address.

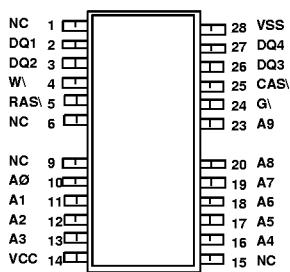
All inputs and outputs are TTL compatible and operate from a single 5 volt supply.

Pin Configurations

* Note: W\ LOW prior to CAS\ LOW, EW detection circuit output is a HIGH (EARLY WRITE). CAS\ LOW prior to W\ LOW, EW detection circuit output is a LOW (LATE WRITE).

Pin Names**1Mx4 DRAM Pinout
20 pin ZIP**

A0-A9	Address Inputs
CAS\	Column Address Strobe
RAS\	Row Address Strobe
W\	Write Control Input
G\	Output Enable
DQ1-DQ4	Data Inputs/Outputs
VCC	Power (+5V $\pm 10\%$)
VSS	Ground
NC	No Connection

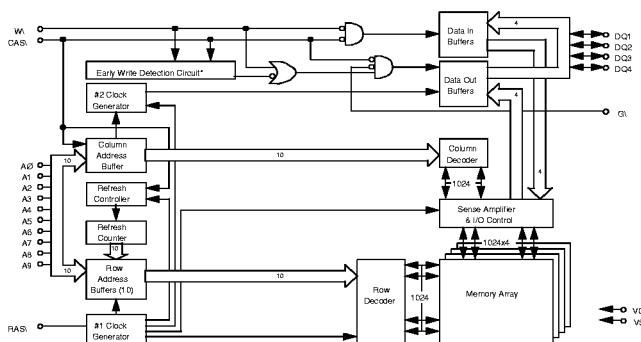
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Block Diagram

1MX4 Monolithic DRAM



Absolute Maximum Ratings*

Voltage on any pin relative to VSS	-1.0V to 7.0V
Operating Temperature TA (Ambient)	
Commercial	0 to +70°C
Industrial	-40°C to +85°C
Military	.55°C to +125°C
Storage Temperature (Ceramic)	-65°C to +150°C
Power Dissipation	1 Watt
Output Current	50 mA

Recommended DC Operating Conditions

(Note 1)

Parameter	Sym	Min	Typ	Max	Units
Supply Voltage	VCC	4.5	5.0	5.5	V
Supply Voltage	VSS	0	0	0	V
Input High Voltage	VIH	2.4	--	5.5	V
Input Low Voltage	VIL	-1.0	--	0.8	V

Notes: 1. All voltage values are with respect to VSS.

*Stress greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions greater than those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Electrical Characteristics

(VCC = 5.0V ±10%) Note 2.

Parameter	Sym	Conditions	Min	Typ	Max	Units
Average Supply Current from VCC Operating (Notes 3, 4)	ICC1	RAS _l , CAS _l , Cycling TRC = TWC = Min, Output Open		100		mA
Supply Current from VCC Standby	ICC2	RAS _l = CAS _l = VIH, Outputs Open RAS _l = CAS _l • VCC-0.2, Outputs Open	3		2	mA
Average Supply Current from VCC Refreshing (Note 3)	ICC3	RAS _l , Cycling, CAS _l = VIH TRC = Min, Outputs Open	100		mA	
Average Supply Current from VCC Fast Page Mode (Notes 3, 4)	ICC4	RAS _l = VII, CAS _l = Cycling TPC = Min, Outputs Open	70		mA	
Average Supply Current from VCC CAS _l before RAS _l , Refresh Mode (Note 3)	ICC6	CAS _l before RAS _l , Refresh Cycling TRC = Min Outputs Open	100		mA	
Input Current	II	0V - VIN - 5.5V All Other Input Pins = 0V	-2	2	2	μA
Off-State Output Current	IOZ	Outputs Floating 0V- V OUT - 5.5V	-10		10	μA
Output High Voltage	VOH	IOH = -5mA	2.4	—	VCC	V
Output Low Voltage	VOL	IOL= 4.2mA	0	—	0.4	V

Notes: 2. Current flowing into an IC is positive, out is negative.

3. ICC1(av), ICC3(av), ICC4(av), and ICC6 are dependent on cycle rate. Maximum current is measured at the fastest cycle rate.

4. ICC1(av), and ICC4(av) are dependent on output loading. Specified values are obtained with the output open.

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Capacitance

(f=1.0MHz, VIN=VCC or VSS)

Parameter	Sym	Test Conditions	Min	Typ	Max	Unit
Address Input Capacitance	CA	VI = VSS	6	pF		
Input Capacitance (D)	CD	f = 1MHz	6	pF		
Input Capacitance (CAS\,W, RAS)	CC, CW, CR	VI = 25mVrms	7	pF		
Output Capacitance (Q)	CQ	VO = VSS, f = 1MHz, VI = 25mVrms	8	pF		

Input Conditions for Each Mode

The EDI441024C provides, in addition to normal Read, Write, and Read-modify-Write operations, a number of other functions, e.g. Fast Page Mode, RAS\ only Refresh, and Delayed Write. The input conditions for each are shown below.

ACT = Active
NAC = Non-active
DNC = Don't care
VLD = Valid
APD = Applied
OPN = Open

Operation	Inputs								Input/Output
	RAS\	CAS\	W\	G\	Row Address	Column Address	D	Q	
Read*	ACT	ACT	NAC	ACT	APD	APD	OPN	VLD	
Early Write*	ACT	ACT	ACT	DNC	APD	APD	VLD	OPN	
Read-Modify-Write*	ACT	ACT	ACT	ACT	APD	APD	VLD	VLD	
RAS\ only Refresh	ACT	NAC	DNC	DNC	APD	DNC	DNC	OPN	
Hidden Refresh	ACT	ACT	DNC	ACT	APD	DNC	OPN	VLD	
CAS\ before RAS\ Refresh	ACT	ACT	ACT	DNC	DNC	DNC	DNC	OPN	
Standby	NAC	DNC	DNC	DNC	DNC	DNC	DNC	OPN	

*Fast Page Mode identical

Switching Characteristics

(VCC = 5.0V±10) NOTE 5.

Parameter	Sym	70ns		80ns		100ns		Units	Notes
		Min	Max	Min	Max	Min	Max		
Access Time from CAS\	TCAC	20		20		25		ns	6,7
Access Time from RAS\	TRAC	70		80		100		ns	6
Column Address Access Time	TCAA	35		40		50		ns	6,9
Access Time from CAS\ Precharge	TCPA	40		45		50		ns	6
Access Time from G\	TOEA	20		20		25		ns	6
Output Low Impedance Time from CAS\ low	TCLZ	0		0		0		ns	
Output Disable Time after CAS\ High	TOFF	3	20	3	20	3	20	ns	11
Output Disable Time after G\ High	TDISOE	0	20	0	20	0	20	ns	11

Notes: 5. An initial pause of 100μs is required after power-up, followed by any RAS\ only refresh or CAS\ before RAS\ refresh cycles with W\ HIGH before proper device operation is achieved. Note that RAS\ may be cycled during the initial pause. Any RAS\ only refresh or CAS\ before RAS\ refresh cycles with W\ HIGH are required after prolonged periods of RAS\ inactivity before proper device operation.

6. Measured with a load circuit equivalent to 2TTL loads and 100pF.
7. Assume that TRCD(max) - TRAD and TRAD(max) • TRAD.
8. Assume that TRCD - TRCD(max) and TRAD - TRAD(max).
9. Assume that TRCD - TRAD - TCAA(max) and TRCD • TRCD(max).
10. Assume that TCP - TCP(max) and TASC • TASC(max).
11. TOFF(max) defines the time at which the output achieves the high impedance state (|IOUT - |±10μA|) and is not reference to VOH(min) or VOL(max).



Timing Requirements

Read, Write, Read-Modify-Write, Refresh, and Fast Page Mode Cycles

(VCC = 5.0V±10%) Notes 12,13

Parameter	Sym	70ns		80ns		100ns		Unit	Notes
		Min	Max	Min	Max	Min	Max		
Refresh Cycle	TREF			16		16		16	ms
RAS\ Precharge Time	TRP	50		60		80		ns	
RAS\ to CAS\ Delay Time	TRCD	20	50	20	60	25	75	ns	14
Delay CAS\ High to RAS\ Low	TCRP	10		10		10		ns	15
CAS\ Precharge Time (Non Page Mode)	TCPN	10		10		10		ns	16
Column Address Delay from RAS\ Low	TRAD	15	35	15	40	20	50	ns	17
Row Address Set Up Time	TASR	0		0		0		ns	
Column Address Set Up Time	TASC	0		0		0		ns	18
Row Address Hold Time	TRAH	10		10		15		ns	
Column Address Hold Time	TCAH	15		15		20		ns	
Transition Time	TT	3	50	3	50	3	50	ns	19

Notes: 12. The timing requirements are assumed TT = 5ns.

13. VIH(min) and VIL (max) are reference levels for measuring timing of input signals.

14. TRCD(max) is specified as a reference point only. If TRCD is less than TRCD(max), access time is TRAC. If TRCD is greater than TRCD(max), access time is defined as TCAC and TCAA as shown in notes 7, 9.

15. TCRP requirement is applicable for all RAS-CAS cycles.

16. TCPN(min) is specified as TCPN(min) = TRCD(min) + TCRP(min) except for TCP of fast page mode cycle.

17. TRAD(max) is specified as a reference point only. If TRAD > TRAD(max), access time is assumed by TCAA for read cycle.

18. TASC(max) is specified as a reference point only of address access time.

19. TT is measured between VIH(min) and VIL(max).

Read and Refresh Cycles

(VCC = 5.0V±10%) Notes 5, 12,13

Parameter	Sym	70ns		80ns		100ns		Unit	Notes
		Min	Max	Min	Max	Min	Max		
Read Cycle Time	TRC	130		150		190		ns	
RAS\ Low Pulse Width	TRAS	70	100,000	80	100,000	100	100,000	ns	
CAS\ Low Pulse Width	TCAS	20	100,000	20	100,000	25	100,000	ns	
CAS\ Hold Time after RAS\ Low	TCSH	70		80		100		ns	
RAS\ Hold Time after CAS\ Low	TRSH	20		20		25		ns	
Read Set Up Time before CAS\ Low	TRCS	0		0		0		ns	
Read Hold Time after CAS\ High	TRCH	0		0		0		ns	20
Read Hold Time after RAS\ High	TRRH	0		0		0		ns	20
Column Address to RAS\ Setup	TRAL	35		40		50		ns	
Precharge to CAS\ Active	TRPC	0		0		0		ns	
Delay Time, Data to G\ Low	TDOEL	0		0		0		ns	
Delay Time, G\ High to Data	TOEHD	20		20		25		ns	
CAS\ Hold Time after G\ Low	THOECH	20		20		25		ns	
RAS\ Hold Time after G\ Low	THOERH	20		20		25		ns	

Notes:20 Either TRCH or TRRH must be satisfied for a read cycle.

4 Megabit DRAM Refresh and Power Up Restrictions

Users of 4 meg DRAMS should be aware of the JEDEC defined test function implementation and its implications. The test function is enabled by entering a CAS\ before RAS\ refresh cycle with W\ held low. The test function will remain enabled for all subsequent memory cycles until a CAS\ before RAS\ refresh with W\ high disables the function. With the test function enabled it is not possible to read any data as the device output is tied to a comparator output, not the data out path. Writes performed with the test function enabled will write data to multiple locations simultaneously. There is no status flag to determine if the test function is active so it is the user's responsibility to insure the device is in the desired operating state. Since the test function can be enabled during a CAS\ before RAS\ refresh with the W\ low, care must be taken that W\ is

high for time TWRP before and is held high for time TWRH after each low going RAS\ transition for normal operation when CAS\ before RAS\ refresh is used.

To prevent the possibility of power up initiating the test function, the 4 meg Dram wake up cycles are now limited to a 100µs pause followed by at least eight CAS\ before RAS\ refresh cycles with W\ high or at least eight RAS\ only refresh cycles. No other RAS\ cycles are allowed for device wake up.

Restriction Summary

- W\ must be high before initiating a CAS\ before RAS\ refresh to prevent the test function from becoming active.
- Wake up cycles are limited to a 100µs pause after power up, followed by at least eight RAS\ only or eight CAS\ before RAS\ cycles with W\ high.



Write Cycle, Early and Delayed Write

(VCC = 5.0V±10%) Notes 5, 12, 13

Parameter	Sym	70ns		80ns		100ns		Unit	Notes
		Min	Max	Min	Max	Min	Max		
Write Cycle Time	TWC	130		150		190		ns	
RAS\ Low Pulse Width	TRAS	70	100,000	80	100,000	100	100,000	ns	
CAS\ Low Pulse Width	TCAS	20	100,000	20	100,000	25	100,000	ns	
CAS\ Hold Time after RAS\ Low	TCSH	70		80		100		ns	
RAS\ Hold Time after CAS\ Low	TRSH	20		20		25		ns	
Write Setup Time before CAS\ Low	TWCS	0		0		0		ns	22
Write Hold Time after CAS\ Low	TWCH	15		15		20		ns	
CAS\ Hold Time after Write Low	TCWL	20		20		25		ns	
RAS\ Hold Time after Write Low	TRWL	20		20		25		ns	
Write Pulse Width	TWP	15		15		20		ns	
Data Set up Time	TDS	0		0		0		ns	22
Data Hold Time after CAS\ Low	TDH	15		15		20		ns	22
Delay Time, G\ High to Data	TOEHD	20		20		25		ns	
G\ Hold Time after Write Low	THWOE	20		20		25		ns	

Read-Write and Read-Modify-Write Cycles

(VCC = 5.0V±10%) Notes 5, 12, 13

Parameter	Sym	70ns		80ns		100ns		Unit	Notes
		Min	Max	Min	Max	Min	Max		
Read-Modify-Write CycleTime	TRWC	180		205		220		ns	21
RAS\ Low Pulse Width	TRASRW	70	100,000	80	100,000	100	100,000	ns	
CAS\ Low Pulse Width	TCASRW	20	100,000	20	100,000	25	100,000	ns	
CAS\ Hold Time after RAS\ Low	TCSHRW	70		80		100		ns	
RAS\ Hold Time after CAS\ Low	TRSHRW	20		20		25		ns	
Read Setup time before CAS\ Low	TRCS	0		0		0		ns	
CAS\ Low to W\ Low Delay	TCWD	50		50		55		ns	22
RAS\ Low to W\ Low Delay	TRWD	100		110		130		ns	22
CAS\ Hold after W\ Low	TCWL	20		20		25		ns	
RAS\ Hold after W\ Low	TRWL	20		20		25		ns	
Write Pulse Width	TWP	15		15		20		ns	
Data Set up Time	TDS	0		0		0		ns	
Data Hold Time after W\ Low	TDH	15		15		20		ns	
Address to W\ Low Delay	TAWD	65		70		80		ns	22
Delay Time, Data to G\ Low	TDOEL	0		0		0		ns	
Delay Time, G\ High to Data	TOEHD	20		20		25		ns	
G\ Hold Time after Write Low	THWOE	20		20		25		ns	

Notes: 21. TRWC is specified as $TRWC(\min) = TRCD(\max) + TCWD(\min) + TRWL(\min) + TRP(\min) + 4TT$.

22. TWCS, TRWD, TCWD, and TAWD do not define the limits of operation, but are included as electrical characteristics only.

When $TWCS \cdot TWCS(\min)$, an early write cycle is performed, and the data output keeps the high-impedance state. When $TRWD \cdot TRWD(\min)$, $TCWD \cdot TCWD(\min)$ and $TAWD \cdot TAWD(\min)$, a read write cycle is performed, and the data of the selected address will be read out on the data output. If neither of the above conditions is satisfied, the condition of Q (at the access time and until CAS\ goes back to VIH) is indeterminate.

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Fast Page Mode Cycle Read, Early Write, Read-Write, Read-Modify-Write Cycles

(VCC = 5.0V±10%) Notes 5, 12, 13

Parameter	Sym	70ns		80ns		100ns		Unit
		Min	Max	Min	Max	Min	Max	
Fast Page Mode Cycle Time	TPC	40	45	55				ns
Fast Page Mode for RW, R/MW Cycle Time	TPRWC	100		105		115		ns
RAS\ Low Pulse Width for Read, Write Cycle	TRASP	70	100,000	80	100,000	100	100,000	ns
CAS\ Low Pulse Width for Read Cycle	TCAS	20	100,000	20	100,000	25	100,000	ns
CAS\ Pulse Width (Page Mode)	TCP	10		10		10		ns
RAS\ Hold Time after CAS\ Low	TRSH	20		20		25		ns

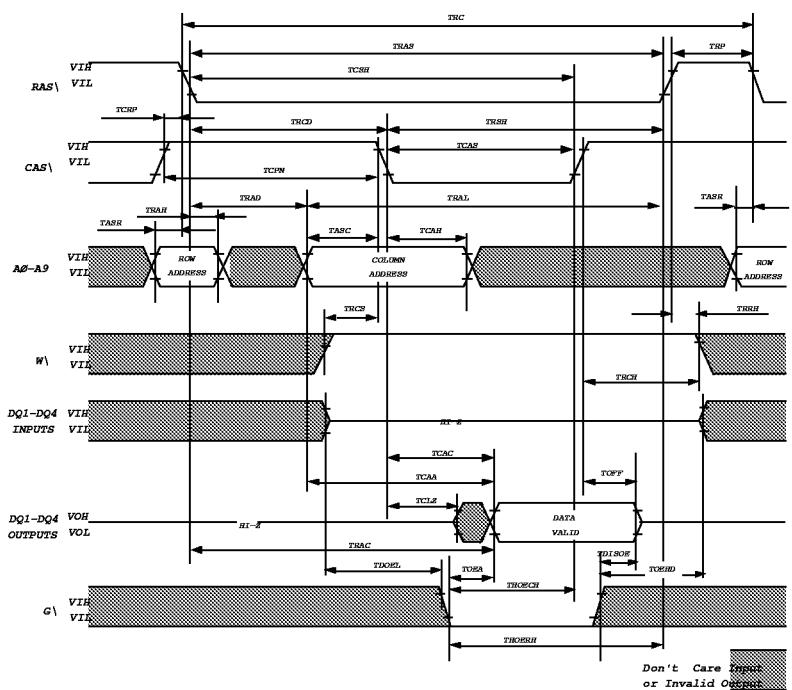
CAS\ before RAS\ Refresh Cycle

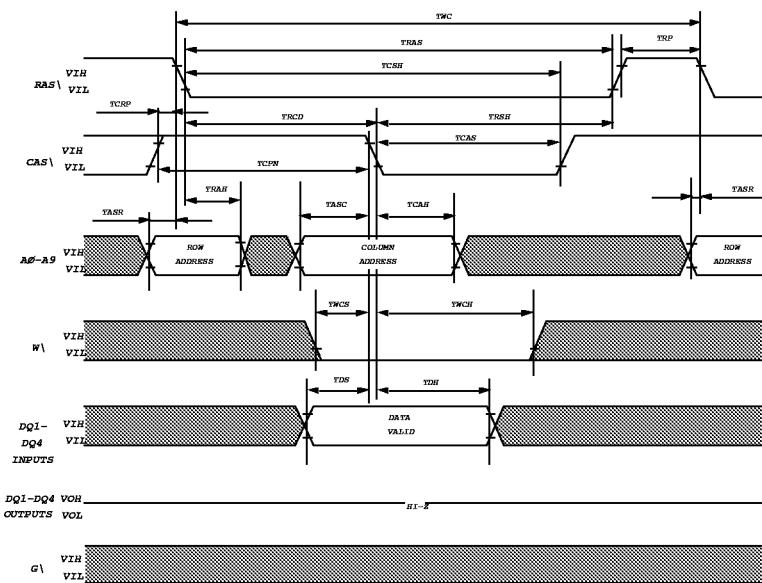
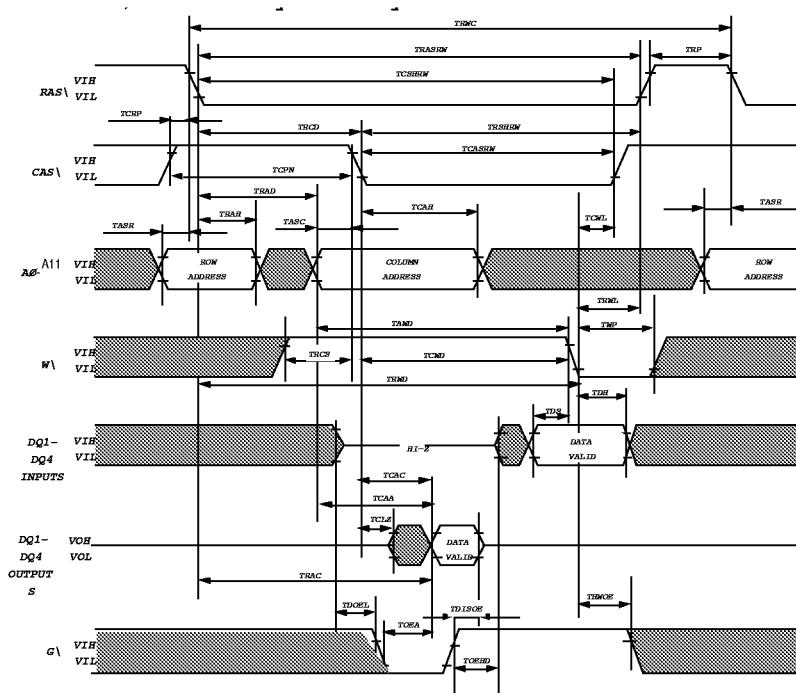
(VCC = 5.0V±10%) Notes 5, 12, 13, 23

Parameter	Sym	70ns		80ns		100ns		Unit
		Min	Max	Min	Max	Min	Max	
CAS\ Setup for CAS\ before RAS\ Refresh	TCSR	10		10		10		ns
CAS\ Hold for CAS\ before RAS\ Refresh	TCHR	10		10		10		ns
Precharge to CAS\ Active	TRPC	0		0		0		ns
Write Set Up	TWRP	10		10		10		ns
Write Hold	TWRH	10		10		10		ns

Note: 23. Eight or more CAS\ before RAS\ cycles are necessary for proper operation of CAS\ before RAS\ refresh mode.

Read Cycle

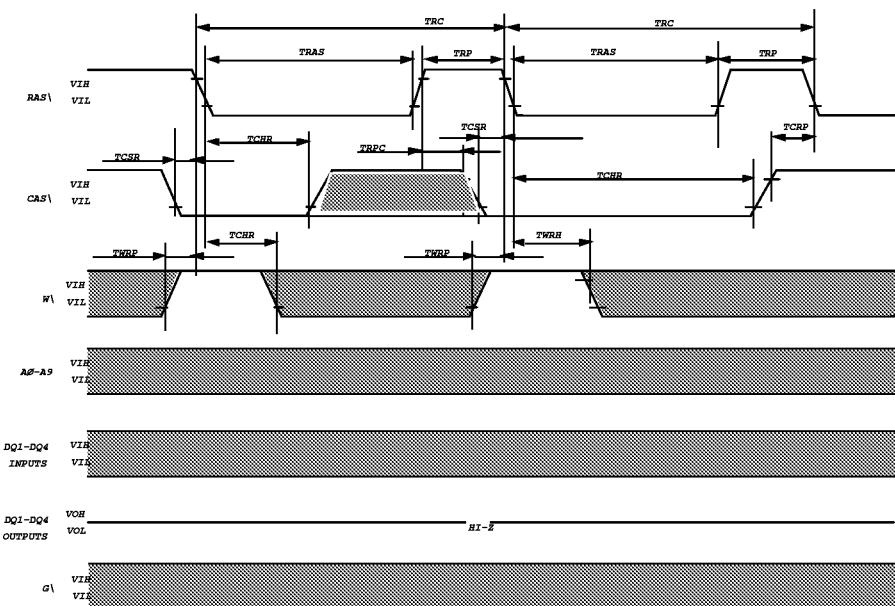


Write Cycle, Early Write

Read-Write, Read-Modify-Write and Delayed Write Cycle


EDI41024C

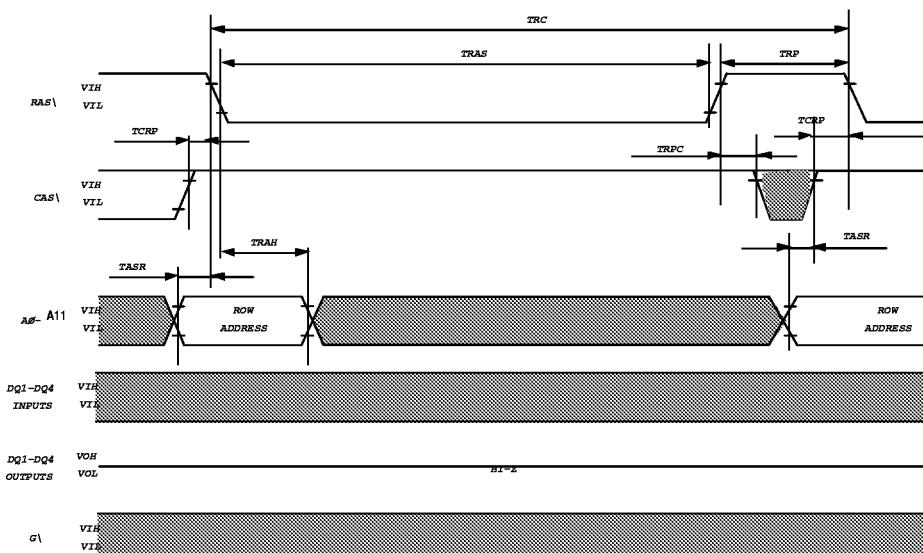
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CAS before RAS Refresh

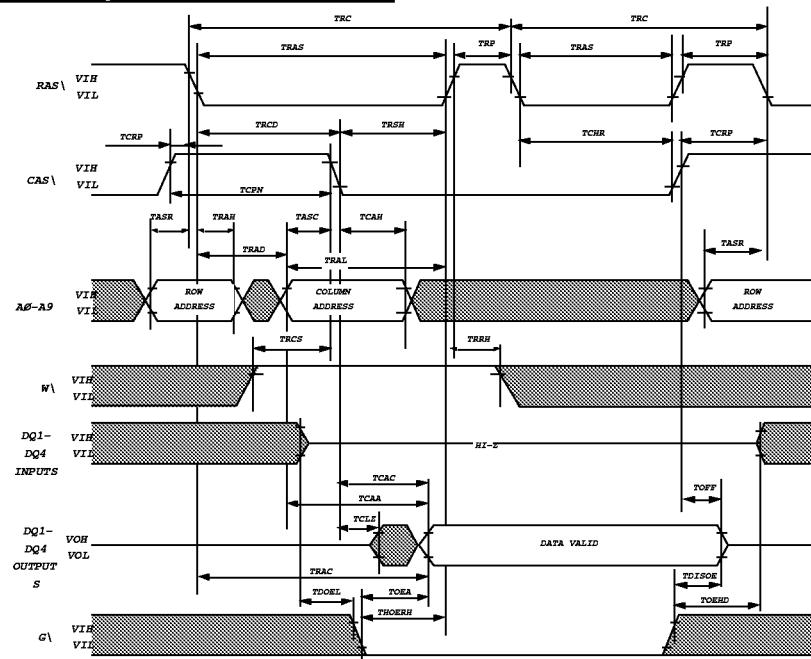
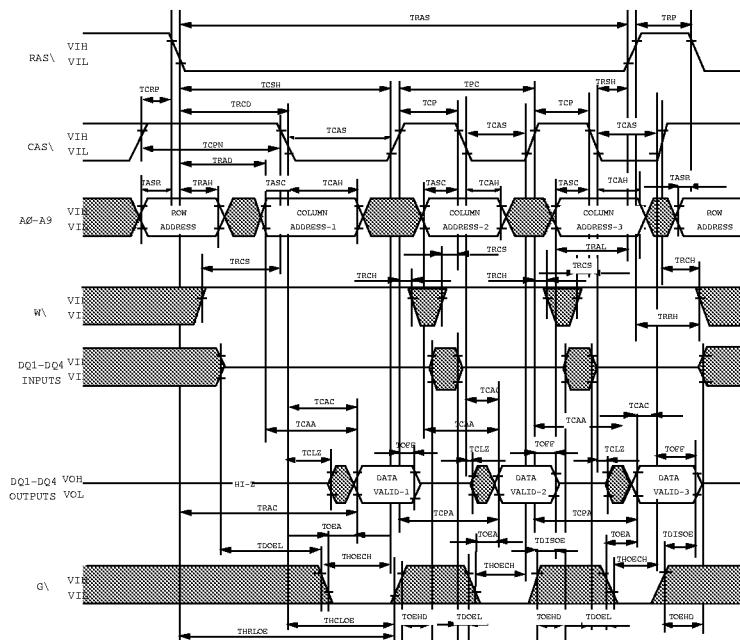


RAS-only Refresh Cycle

Note 24

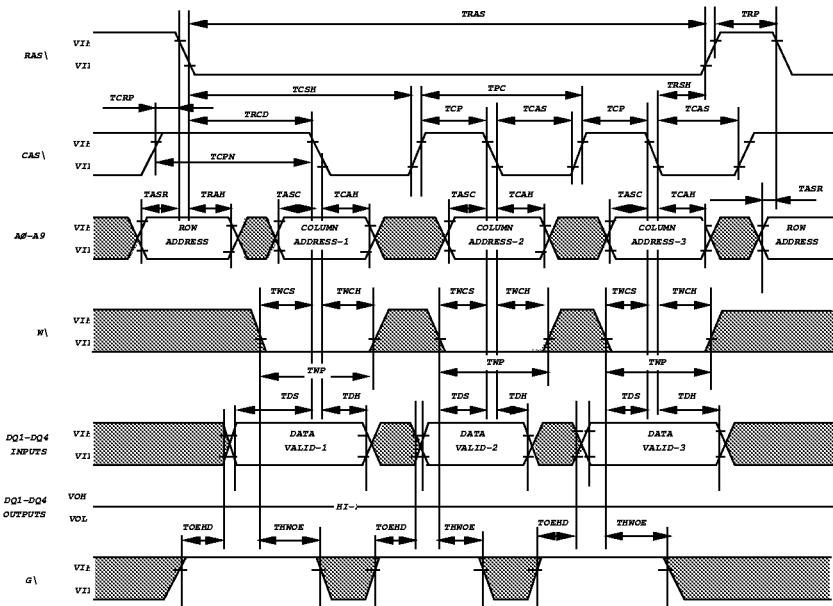


Note 24: W Don't Care

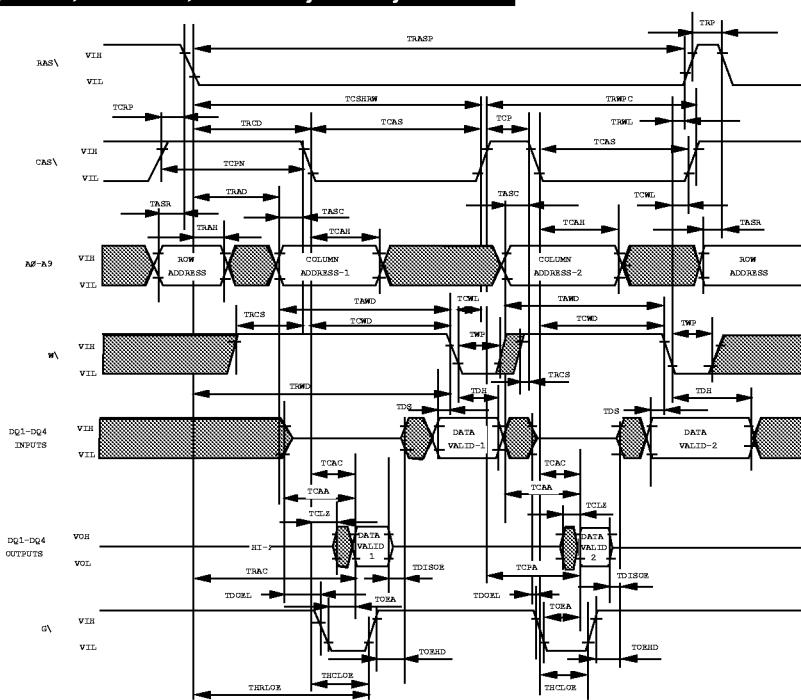
Hidden Refresh Cycle

Fast-Page-Mode, Read Cycle


EDI441024C
1Megx4 Fast Page DRAM

Fast-Page-Mode, Early Write Cycle



Fast-Page-Mode, Read-Write, Read-Modify-Write Cycle





Ordering Information

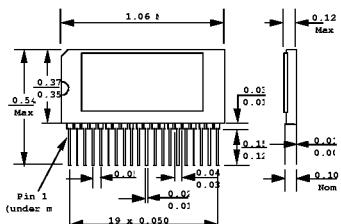
Part No.	Speed (ns)	Package No.
EDI441024C70LZB	70	18
EDI441024C80LZB	80	18
EDI441024C100LZB	100	18

Notes: For Commercial, Industrial or Mil-Temp-Only grade products use C,I or M respectively to replace B in the suffix of the part number, eg. EDI441024C70LZB becomes EDI441024C70LZI (Industrial Temp Range).

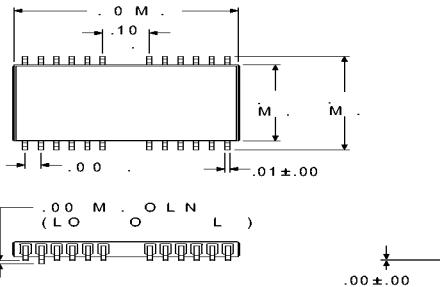
Part No.	Speed (ns)	Package No.
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EDI441024C80BB	80	317
EDI441024C100BB	100	317
EDI441024C70FB	70	347
EDI441024C80FB	80	347
EDI441024C100FB	100	347

Package Description

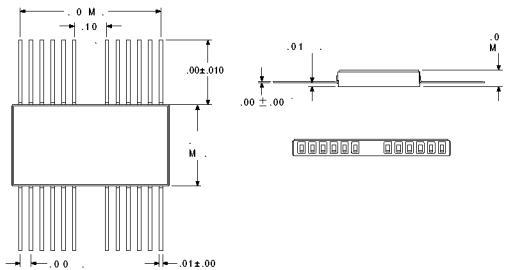
Package No. 18 20 Pin Ceramic Zip



Package No. 317 24/28 Pin Ceramic Thinpack™ Flatpack Weight = 1.2 gm Theta Jc = 15°C/W Theta Ja = 38°C/W



Package No. 347 24/28 Pin Ceramic Flatpack Weight = 1.2 gm Theta Jc = 15°C/W Theta Ja = 38°C/W



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